

**IN THE SPECIFICATION**

The paragraph beginning at page 4, line 17 is amended as follows:

**Figure 3** illustrates further processing that is carried out where passivation layer 20 and metallization 14 are covered with a metal first layer 26 a metal second layer 28, a metal third layer 30, and a metal upper layer 32. In one embodiment, metal first layer 26 is a refractory metal such as titanium, zirconium, hafnium, and the like. Other refractory metals for metal first layer 26 include nickel, cobalt, palladium, platinum, and the like. Other refractory metals for metal first layer 26 include chromium, molybdenum, tungsten, and the like. Other refractory metals for metal first layer 26 include the refractory metals scandium, yttrium, lanthanum, cerium, and the like, and the metals lanthanum, cerium and the like. One property embodiment is a metal first layer 26 that exhibits sufficient adhesion to the metallization that liftoff or spalling thereof will not occur during fabrication, test, and ordinary field use.